

# **Die Attach Machine Market by Type (Flip Chip Bonder and Die Bonder), Technique (Epoxy, Soft Solder, Sintering, Eutectic, and Others), and Application (RF and MEMS, Optoelectronics, Logic, Memory, CMOS Image Sensors, LED, and Others): Global Opportunity Analysis and Industry Forecast, 2021–2028**

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## **Abstracts**

The global die attach machine market was valued at \$1,129.0 million in 2020, and is projected to reach \$1,813.1 million by 2028, registering a CAGR of 6.1% from 2021 to 2028. Die attach machine is used for attachment of semiconductor device die and its package. Additionally, it is a backend process of chip manufacturing and also a key component of the semiconductor supply chain.

Factors such as rise in demand for electronics products; growth in demand for hybrid circuits from medical, military, photonics, and wireless electronics applications; and growth of the semiconductor packaging industry drive the market growth. However, the fluctuation in raw material prices hinders the market growth. Furthermore, growth in usage of led circuits offers lucrative growth opportunities for the market player during the forecast period.

The global die attach machine market is segmented on the basis of type, technique, application, and region. By type, the market is categorized into flip chip bonder and die bonder. Depending on technique, it is fragmented into epoxy, soft solder, sintering, eutectic, and others. On the basis of technique, it is categorized into epoxy, soft solder, sintering, eutectic, and others. Depending on application, it is fragmented into RF and MEMS, optoelectronics, logic, memory, CMOS image sensors, LED, and others. Region wise, the market is analyzed across North America, Europe, Asia-Pacific, and LAMEA.

## COMPETITION ANALYSIS

Key companies profiled in the die attach machine market report include Anza Technology, Inc, ASM Pacific Technology Limited, BE Semiconductor Industries N.V, Dr. Tresky AG, Fasford Technology Co. Limited, Inseto UK Limited, Kulicke and Soffa Industries, Inc., MicroAssembly Technologies Limited, Palomar Technologies, and Shinkawa Limited.

## KEY BENEFITS FOR STAKEHOLDERS

The report provides an extensive analysis of the current and emerging die attach machine market trends and dynamics.

In-depth market analysis is conducted by constructing market estimations for the key market segments between 2020 and 2028.

Extensive analysis of the die attach machine market is conducted by following key product positioning and monitoring of the top competitors within the market framework.

A comprehensive analysis of all regions is provided to determine the prevailing opportunities.

The global die attach machine market forecast analysis from 2021 to 2028 is included in the report.

The key market players within die attach machine market are profiled in this report and their strategies are analyzed thoroughly, which help understand the competitive outlook of the die attach machine industry.

## KEY SEGMENTS

### BY TYPE

Flip Chip Bonder

Die Bonder

## BY TECHNIQUE

Epoxy

Soft Solder

Sintering

Eutectic

Others

## BY APPLICATION

RF and MEMS

Optoelectronics

Logic

Memory

CMOS Image Sensors

LED

Others

## BY REGION

North America

U.S.

Canada

Mexico

Europe

Germany

UK

France

Italy

Rest of Europe

Asia-Pacific

China

India

Japan

South Korea

Rest of Asia-Pacific

LAMEA

Latin America

Middle East

Africa

## KEY PLAYERS

Anza Technology, Inc

ASM Pacific Technology Limited

BE Semiconductor Industries N.V

Dr. Tresky AG

Fasford Technology Co. Limited

Inseto UK Limited

Kulicke and Soffa Industries, Inc.

MicroAssembly Technologies Limited

Palomar Technologies

Shinkawa Limited

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